

PCMO resistor trimmer**Inventor: Sheng Teng Hsu****Field of the invention**

This invention relates in general to a circuit for resistor trimming, and more particularly, to a circuit for reversible precision adjustment or matching of thin film programmable resistors.

Background of the invention

Resistors play an important role in microelectronic circuits. A resistor is an electrical component designed to have an electrical resistance independent of the applied current or voltage. Two important issues in the fabrication of resistors in microelectronic processing are the accuracy of the individual resistor and the accuracy of the ratio of a pair of resistors.

Many microelectronic circuits, such as precision analog amplifiers, require the individual resistors to have a specific value to achieve the desired circuit performance level. Other circuits, such as differential amplifiers and analog-to-digital (ADC) or digital-to-analog (DAC) converter applications, require the accuracy matching of two resistors, but do not require a specific value of the resistors. Matching resistors means that the resistors are to have the same resistance value but may not be of any specific value due to manufacturing variations.

Because process variations affect matched pair of resistors equally, high accuracy in matching resistors is easier to obtain in microelectronic fabrication process than in setting individual resistor with a certain resistance value. But for some circuits, this degree of precision is still not adequate. For example, the resistance variations of merely 0.025 percent may compromise the linearity and accuracy of a 12-bit analog-to-digital converter. Thus maintaining the resistor-matching characteristics required for accurate performance is of paramount importance in certain precision analog circuits.

Resistor trimming method is the most common method used to adjust or match the resistors in these circuits. The term "resistor trimming" means the fine adjustment of the resistance of a resistor in a circuit, either to reach a particular resistance or to match a reference resistor. The resistors could be trimmed by various mechanical, electrical, or chemical methods. For example, a resistor can be trimmed by laser shaping, fuse blowing, or by changing the conductivity of the resistor by activation of impurity doping.

In these prior art resistor trimming methods, the trimming action can be extremely difficult to reverse. The adjustment of the resistance in these methods mostly can only occur in one direction. For example, by

laser trimming, the resistance can only increase due to the shaping or the shaving of the resistance material. By activation of impurity doping such as metal migration, the resistance can only decrease due to the migration of the impurities into the resistance material.

Over the years, new resistor and conductor materials have been developed. Specifically, materials used in resistive memory cells have programmable resistance and exhibit reversible resistance change based on external influences. For example, materials having electric pulse-induced-resistive-change (EPIR) effect used in multi-bit non-volatile memory devices can exhibit reversible and repeatable resistance changes under the influence of electrical pulses. The EPIR effect can be found in thin film colossal magnetoresistive (CMR) materials such as $\text{Pr}_{0.7}\text{Ca}_{0.3}\text{MnO}_3$ (PCMO). For detail of the EPIR effect, see S.Q. Liu, N.J. Wu, A. Ignatiev, "A new concept for non-volatile memory: the Electric-Pulse Induced Resistive change effect in colossal magnetoresistive thin film", Proceedings of Non-Volatile Memory Technology Symposium 2001, San Diego, California, Nov. 2001, p. 18-24. Other examples of a semiconductor resistive memory device are the metal-amorphous silicon-metal (MSM) electrical memory switch disclosed in U.S. patent 5,541,869 of Rose et al., and the electrical phase change materials such as TeGeSb, disclosed in U.S. patent 5,912,839 of Ovshinsky et al.

Thus it is advantageous to employ programmable resistance materials developed for resistive memory cells in resistor trimmer circuits for the advantage of reversibly trimmable resistance.

Summary of the invention

The present invention discloses a reversible resistor trimming circuit to match resistances with the use of programmable resistance material. By using the materials that allow the resistance to be programmed reversibly, the present invention allows the adjustment of a matching resistor to match a reference resistor in both increasing and decreasing directions.

In the first embodiment, the present invention reversible resistor trimming circuit comprises a resistor bridge network comprising a matching resistor and a reference resistor, a comparator and a pulse feedback circuit. The reversible resistor trimming circuit first compares the matching resistor to the reference resistor through the comparator circuit. Then the comparator circuit generates a comparing signal indicative of the difference. This signal then controls the polarity, the amplitude or the duration of an electrical pulse provided by the pulse feedback circuit to adjust the resistance of the matching resistor. The process is repeated until the resistances of the matching resistor and the reference resistor are matched. By using a matching resistor made of

programmable resistance materials, the present invention provides the resistor trimming in both directions, thus allows the adjustment of resistance over-trimming.

The programmable resistance material disclosed in the present invention is often employed in resistive memory device such as metal-amorphous silicon-metal (MSM) materials, phase change materials, or perovskite materials exhibiting colossal magnetoresistive effect or high temperature superconducting effect. The metal-amorphous silicon-metal (MSM) material comprises boron doped amorphous silicon located between two metal electrodes. The phase change materials employed in resistive memory devices comprises at least one chalcogen and may include one or more transition metals. The perovskite materials exhibiting colossal magnetoresistive effect or high temperature superconducting effect employed in resistive memory devices are manganite materials such as PCMO.

Depending on the programmable resistance materials used, the feedback circuit of the reversible resistor trimming circuit can provide the resistance adjustment pulses having the polarity, amplitude or duration directly related to the comparing signal. The pulse amplitude, the pulse duration and the number of pulses can also be controlled to improve the resistance overshoot.

In another embodiment of the present invention, the reversible resistor trimming circuit further comprises a transmission gate between the resistor bridge network and the comparator circuit to isolate the resistor bridge network, and a delay circuit to improve the timing of the feedback circuit.

Brief description of the drawings

Fig. 1 shows the resistance function of a PCMO material.

Fig. 2 shows the reversibility of the resistance of a PCMO material.

Fig. 3 shows the first embodiment of the present invention reversible resistor trimming circuit.

Fig. 4 shows the block diagram of another embodiment of the present invention reversible resistor trimming circuit.

Fig. 5 shows an equivalent circuit of the block diagram in Fig. 4.

Fig. 6 shows the timing of the transmission gates.

Detailed description of the invention

The present invention discloses a novel circuit to reversibly trim the resistor to match a reference resistor in electronics circuits by the use of programmable resistance material.

In the prior art resistance trimmer circuit, the act of resistor trimming often cannot be reversed due to the irreversibility of the resistance material or the trimming process. The prior art resistance material or the trimming process usually only allows the resistance to either increase or decrease, but not both.

For example, by laser trimming, the resistance can only increase due to the shaving or the shaping of the resistive material. Therefore the resistor material is designed with a very low initial resistance value, and then is trimmed to the appropriate resistance. If the resistor is trimmed excessively, the circuit cannot be repaired because the resistor cannot be reversed to the previous lower value. Similarly, the resistor trimming process is irreversible in fuse blowing or in zener diode zapping.

Another prior art method for resistor trimming is to change the resistance of the materials by impurity diffusion, such as n-type (e.g. phosphorous) doped or p-type (e.g. boron) doped or metal (e.g. aluminum) doped silicon. The initial resistance of the silicon film is normally high, and can then be decreasingly adjusted (or trimmed) by diffusing the impurity into the silicon. Again, the resistance can only decrease due to the migration of the impurity into the resistor, and the trimming action cannot be reversed.

Recent developments of RRAM (resistive random access memory) circuit have introduced a class of materials (programmable resistance

material) that has electrical resistance characteristics that can be changed by external influences. From an electrical point of view, this class of programmable resistance materials can be modeled as a programmable variable resistor. The variable resistor can be programmed to have high resistance or low resistance, or any intermediate resistance values. The different resistance values of the variable resistor represent the information stored in the RRAM circuit.

The present invention employs this class of materials in a reversible resistor trimming circuit. By using the materials that allow the resistance to be programmed reversibly, the present invention allows the the adjustment of a matching resistor to match a reference resistor in both increasing and decreasing directions.

In the first embodiment, the present invention reversible resistor trimming circuit comprises a resistor network comprising a matching resistor and a reference resistor, a comparator and a pulse feedback circuit. The reversible resistor trimming circuit

- first compares the matching resistor to the reference resistor through the comparator circuit;
- then the comparator circuit generates a comparing signal output indicative of the difference between the reference resistor and the matching resistor;

- then the output comparing signal controls either the polarity, the amplitude or the duration or any combinations of an electrical pulse generated by the pulse feedback circuit.

The process is repeated until the resistances of the matching resistor and the reference resistor are equal.

The electrical pulses generated by the pulse feedback circuit is controlled by the comparing signal and applies to the matching resistor to adjust the resistance of the matching resistor toward the resistance of the reference resistor. By using a matching resistor made of programmable resistance materials, the present invention provides the resistor trimming in both directions, thus allows the adjustment of resistance over-trimming. Since the reversible resistor trimming circuit is a feedback circuit, the resistance variation can be linear or non linear. In addition, the reversible resistor trimming circuit can be employed to calibrate the matching resistances at any time to ensure resistances matching against time or temperature drift.

The resistor network comprises a matching resistor fabricated using a programmable resistance material, and a reference resistor. The resistance of the matching resistor initially can be higher or lower than the resistance of the reference resistor, and ultimately will be trimmed to match the resistance of the reference resistor. The resistor network is

preferably a bridge network that comprises a 4 resistor bridge, including two other equal resistors.

The resistor bridge serves as input to a comparator circuit which compares the resistance of the matching resistor and the reference resistor and produces a comparing signal output indicative of the difference. The comparator circuit is preferably a differential amplifier, comprising an operational amplifier. The sensitivity of the comparator circuit controls the precision of the resistor trimming circuit. Highly sensitive comparator circuit can allow more precision resistor matching due to the sensitivity of the comparing signal.

The output of the comparator circuit (meaning the comparing signal) is fed into the pulse feedback circuit which produces an electrical pulse to the resistor bridge to adjust the resistance of the matching resistor to reduce the difference in the resistances as shown by the comparing signal. The pulse feedback circuit is designed to provide the appropriate pulses (e.g. pulse polarity, pulse amplitude, pulse duration, number of pulses) to induce the appropriate resistance change in the matching resistor. For example, the pulse feedback circuit provides the pulses with the correct polarity for reversing resistance change for materials where the direction of the resistance change depends on the polarity of the induced pulses; and provides the pulses with the correct amplitude for materials where the direction of the resistance change depends on the

amplitude of the induced pulses. The pulse feedback circuit is preferably a programmable pulse generator, controlled by the comparing signal.

The material of the matching resistor used in the present invention reversible resistor trimming circuit is a programmable resistance material, meaning the resistance of the material can be reversibly adjusted with the application of an electrical signal, preferably a pulsed signal. The resistance of these materials is then a function of the number of pulses, the polarity, the amplitude or the duration of the applied electrical pulses. The programmable resistance materials disclosed in the present invention are often employed in resistive memory devices. The examples of such materials are metal-amorphous silicon-metal (MSM) materials, phase change materials, and perovskite materials exhibiting colossal magnetoresistive effect or high temperature superconducting effect.

The metal-amorphous silicon-metal (MSM) material comprises a resistive layer such as boron doped amorphous silicon located between two electrodes, one electrode is Cr and the other is V, Co, Ni, Pd, Fe or Mn (see U.S. patent 5,541,869 of Rose et al., hereby incorporated by reference). The variable resistance characteristic of the metal-amorphous silicon metal composite comes from the diffusion of the metal electrodes into the amorphous silicon. The direction of the resistance

changes in this programmable resistance material depends on the polarity of the applied pulses. One polarity causes a decrease in the value of the resistance, and the opposite polarity causes an increase in the value of the resistance. The resistance of this programmable resistance material can be adjusted to a target value by varying the voltage pulse duration instead of varying the magnitude. Thus, the resistance of a matching resistor can be adjusted to a reference resistance by the pulse feedback circuit, which selects a suitable polarity and/or voltage amplitude based on the comparing signal and then applies a pulse of an appropriate duration. If the process overshoots, the comparing signal will respond appropriately, and thus will control the pulse feedback circuit to reverse the polarity of the applied pulse. In addition, smaller pulse duration can be used to reduce further overshoot amount.

Another kind of programmable resistance material employed in resistive memory device is a chalcogenide material. Chalcogenide alloys can exhibit two different stable reversible structural states, namely an amorphous state with high electrical resistance and a polycrystalline state with lower electrical resistance. Since the binary information is represented by two different phases of the material, it is inherently non-volatile and requires no energy to keep the material in either of its two stable structural states. Resistive heating by an electrical current can be

used to change the phase of the chalcogenide materials. Therefore information can be stored (or written) to a chalcogenide material by applying a current pulse to the chalcogenide material. A short pulse of high electrical current will give rise to a high temperature above the melting temperature to form the amorphous state, and a long pulse of lower electrical current will crystallize the material at a lower temperature to form the polycrystalline state. The information can then be sensed (or read) by sensing the voltage across the chalcogenide material using a constant current source, or by sensing the current through the chalcogenide material using a constant voltage source.

In the chalcogenide material disclosed by Buckley et al. in U.S. patent 3,886,577, the resistor can be set to a low resistance value after an electrical pulse with sufficiently high voltage and sufficiently long duration is applied, and afterwards, if a high current and shorter duration electrical pulse is applied, the resistor may be set to a high resistance value.

Examples of phase change materials employed in resistive memory devices were provided by Ovshinsky et al., in U.S. patents 3,271,591; 3,530,441; 5,166,758; 5,296,716; 5,335,219; 5,534,711; 5,536,947; 5,596,522; 5,687,112 and 5,912,839, the disclosures of which are incorporated by reference herein. The disclosed phase change materials

include at least one chalcogen and may include one or more transition metals. The term "chalcogen" refers to the elements in group VI of the periodic table. Chalcogenide alloys contain at least one of these elements such as the alloys of germanium, antimony, or tellurium. The term "transition metal" refers to the elements with the atomic number 21-30, 39-48, 57 and 72-80, such as Cr, Fe, Ni, Nb, Pd, and Pt. An example of the phase change materials is a Te-Ge-Sb ternary system with the average concentration of Te from about 48% to about 58%, average concentrations of Ge from about 8% to about 40%, and the remainder is Sb. The resistance of this phase change material is a function of the applied pulse voltages, reversibly and repeatably. Typically the applied voltage pulses have a pulse width that are between 25 to 250 ns.

The resistance of this programmable resistance material can be adjusted to a target value by varying the voltage pulse amplitude. Thus, the resistance of a matching resistor can be adjusted by the selection of suitable voltage amplitude.

Examples of perovskite materials exhibiting colossal magnetoresistive effect or high temperature superconducting effect employed in resistive memory devices were provided in U.S. patent 6,204,139 of Liu et al., and 6,473,332 of Ignatiev et al., hereby incorporated by reference. The disclosed perovskite materials useful in the memory devices are characterized by a programmable resistance through the application of

electrical pulses and an increase or decrease in the resistance of the material depending on the polarity of the applied electrical pulses. The rate of resistance change depends on the following parameters: the pulse amplitude, the pulse waveform, the pulse duration and the history of the change of the resistance. Thus, similar to the metal-amorphous silicon-metal materials, the resistance of a matching resistor employing these programmable resistance materials can be adjusted by the selection of suitable polarity and/or voltage amplitude.

$\text{Pr}_{0.7}\text{Ca}_{0.3}\text{MnO}_3$ (PCMO) is a typical perovskite material that can be used in a matching resistor for the present invention reversible resistor trimming circuit. Fig. 1 shows the resistance of a thin film PCMO material as a function of the number of applied voltage pulses. This figure shows that the resistance of a PCMO material can be reversibly adjusted to any value within certain resistance limits, from 400Ω to about $200\text{k}\Omega$ in this sample. The resistance limits can be modified and fabricated based on the thin film properties such as thickness and microstructure. Each point in the resistance curves of Fig. 1 consists of 10 pulses of 4 V, 5 ns voltage pulses in the direction of increasing resistance. As shown in Fig. 1, the PCMO resistance increases steadily with the number of applied pulses. The voltage pulse applied to the PCMO thin film resistor is preferably ranging from 1 fs to 1 s, and more preferably from 1 ns to 1 μs , and preferably ranging from 100 mV to

100V, and more preferably from 100 mV to 20V. When the polarity of the voltage pulse is reversed, the resistance of the resistor decreases. The resistance of the PCMO thin film sample drops from a high resistance of 200 k Ω to a lower value of 400 Ω after the application of a 15 V, 0.01 s voltage pulse with a reverse polarity. Usually for PCMO materials, the negative pulses decrease the resistance. The rate of resistance change depends on the pulse width and pulse amplitude. Thus for a pulse with very narrow pulse width or very small pulse amplitude, the resistance change by each pulse is very small. The negative pulse of 15 V, 0.01 s reduces the resistance from 200 k Ω to 400 Ω while the 10 positive pulses of 4 V, 5 ns only increase the resistance by about 4 to 6 k Ω .

Fig. 2 shows the reversibility of the PCMO material. A series of alternate polarity pulses of 4.8 V, 100 ns is applied to the PCMO thin film, and drives the PCMO resistance repeatably from a low resistance of 700 Ω to a higher resistance of 1100 Ω and back.

The PCMO thin film resistor used in Figs. 1 and 2 was deposited on Pt on a LaAlO₃ (LAO) substrate. Alternately, the PCMO thin film can be deposited on a YBa₂Cu₃O₇ (YBCO) layer. Two silver electrodes are deposited on the top surfaces of the PCMO and the Pt respectively. Alternately, the electrode contacts may be made of Ag, Au, Pt or other metal or a conducting oxide

PCMO belongs to a class of materials having perovskite structure such as colossal magnetoresistive (CMR) materials, or high temperature superconductivity (HTSC) materials that can have their resistance changed by an external electric field, thus can be used in the present invention as the programmable resistance material. HTSC materials such as $\text{PbZr}_x\text{Ti}_{1-x}\text{O}_3$, YBCO (Yttrium Barium Copper Oxide, $\text{YBa}_2\text{Cu}_3\text{O}_7$ and its variants), have their main use as a superconductor, but since their conductivity can be affected by an electrical current or a magnetic field, these HTSC materials can also be used as matching resistors in the present invention.

Typical perovskite materials having CMR effect are the manganite perovskite materials of the $\text{Re}_{1-x}\text{Ae}_x\text{MnO}_3$ structure (Re: rare earth elements, Ae: alkaline earth elements) such as $\text{Pr}_{0.7}\text{Ca}_{0.3}\text{MnO}_3$ (PCMO), $\text{La}_{0.7}\text{Ca}_{0.3}\text{MnO}_3$ (LCMO), $\text{Nd}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ (NSMO). The rare earth elements are La, Ce, Pr, Nd, Pm, Sm, Eu, Gd, Tb, Dy, Ho, Er, Tm, Yb, and Lu. The alkaline earth metals are Be, Mg, Ca, Sr, Ba, and Ra.

Suitable programmable resistance materials for the present invention include CMR materials and HTSC materials such as PrCaMnO (PCMO), LaCaMnO (LCMO), LaSrMnO (LSMO), LaBaMnO (LBMO), LaPbMnO (LPMO), NdCaMnO (NCMO), NdSrMnO (NSMO), NdPbMnO (NPMO), LaPrCaMnO (LPCMO), and GdBaCoO (GBCO).

Using programmable resistance materials as described above, the present invention discloses a novel circuit to reversibly trim a resistor to match a reference resistor in electronics circuits. Fig. 3 shows the first embodiment of the present invention reversible resistor trimming circuit. A resistor bridge network 100 comprising a matching resistor 101 and a reference resistor 102 is providing inputs to a comparator 105. The resistor bridge network is preferably a resistor bridge, thus further comprises two equal resistors 103 and 104. The output of the comparator is fed to a pulse feedback circuit 107. The pulse feedback circuit takes the comparator output to control the feedback pulses to the resistor bridge network 100 for adjusting the resistance of the matching resistor 101.

The reversible resistor trimming circuit first compares the matching resistor 101 to the reference resistor 102 through the comparator circuit 105. Then the comparator circuit 105 generates a comparing signal indicative of the difference between the reference resistor 102 and the matching resistor 101. The comparing signal then controls either the number of pulses, the polarity, the amplitude or the duration or any combinations of the electrical pulses provided by the pulse feedback circuit 107 to be applied to the matching resistor 101 to adjust its resistance to match that of the reference resistor 102. The process is

repeated until the resistances of the matching resistor and the reference resistor are properly matched.

The matching resistor can be made from a metal-amorphous silicon-metal material or a perovskite material whose resistance is a function of the applied pulse polarity, amplitude, duration or the number of pulses. Since the direction of the resistance changes of the metal amorphous silicon-metal material or a perovskite material depends on the polarity of the applied pulses, the feedback circuit provides the resistance adjustment pulses having the polarity dictated by the comparing signal. The pulse amplitude, the pulse duration and the number of pulses can also be controlled to improve the damping of the resistance oscillation.

The matching resistor can be made from a phase change material (such as a chalcogenide alloy with or without a transition metal). Since the direction of the resistance changes of the phase change material depends on the amplitude of the applied pulses, the feedback circuit provides the resistance adjustment pulses having the amplitude dictated by the comparing signal. The pulse duration and the number of pulses can also be controlled to improve the resistance oscillation.

The electrical pulses provided by the pulse feedback circuit is preferably voltage pulses, but can be current pulses. The duration of the electrical pulses is preferably between 10 fs and about 10 ms, and most preferably between 100 fs and 100 μ s. The amplitude of the electrical

pulses is preferably between 0.1 V and about 100 V. The number of pulses applied is preferably between 1 pulse and 1000 pulses.

Fig. 4 shows the block diagram of another embodiment of the present invention reversible resistor trimming circuit. The reversible resistor trimming circuit provides bipolar switching property, and comprises a resistance bridge 130, a transmission gate 131, a comparator circuit 132, a delay circuit 133, and a pulse feedback circuit 134.

The resistance bridge 130 comprises a matching resistor and a reference resistor, and preferably comprises two other equal resistors. The resistance bridge 130 is to provide the resistance states of the matching resistor and the reference resistor to the comparator circuit 132. A transmission gate 131 is provided between the resistance bridge 130 and the comparator circuit 132, preferably serving as an isolation between the resistance bridge 130 and the input of the comparator circuit 132. The transmission gate 131 further comprises a control signal 141 for controlling the transmission gate 131. When the gate control 141 closes, the transmission gate 131 is off and the resistance bridge 130 is isolated from the comparator circuit 132. The comparator circuit 132 is to compare the resistance states of the matching resistor and the reference resistor from the resistance bridge 130 and to generate a comparing signal indicative of the difference. The comparator circuit is preferably a differential amplifier for amplifying the difference in

resistances between the matching resistor and the reference resistor. The delay circuit 133 is optional and is preferably inserted to stabilize the feedback circuit. The delay circuit 133 can be omitted without causing serious effect on the resistor trimming capability of the system. The feedback circuit 134 is designed to take the comparing signal generated by the comparator and to provide an electrical pulse fed back to the resistance bridge to modify the matching resistor. The feedback circuit 134 is preferably a second transmission gate for isolating the feedback path between the resistance bridge 130 and the output of the comparator circuit 132. The transmission gate 134 further comprises a gate control 144 to control the transmission gate 134. When the gate control 144 closes, the transmission gate 134 is off and the resistance bridge 130 is isolated from the output of the comparator circuit 132.

The timing of the two transmission gates 131 and 134 is such that the resistance bridge is prevented from completing the loop. When the transmission gate 131 is open, the transmission gate 134 is close and vice versa. The first transmission gate is pulsed open for the comparator circuit to compare the resistance states of the resistance bridge and to generate a comparing signal. The second transmission gate is pulsed open only during the close of the first transmission gate to propagate the comparison signal to the resistor bridge to modify the matching resistor.

Fig. 5 shows an equivalent circuit of the block diagram in Fig. 4. The resistance bridge 130 comprises a matching resistor R_2 and a reference resistor R_1 , together with 2 equal resistors R . The matching resistor R_2 is made of programmable resistance materials such as PCMO, or metal-amorphous silicon-metal material whose resistance increases or decreases depending on the polarity of the applied pulses. A bias voltage $V_{\text{bridge}}/\text{ground}$ is applied to two ends C and D of the resistance bridge, dividing the 4 resistors into 2 branches, each branch comprising one of the two equal resistors R . Fig. 5 shows the two equal resistors R connected to V_{bridge} in the resistance bridge, but these two equal resistors R can be connected to ground, providing that these two resistors are in different branches. This bias voltage V_{bridge} will generate two voltages V_A and V_B in nodes A and B of the resistance bridge. When these two voltages V_A and V_B are equal, the resistances of the matching resistor and the reference resistor are matched.

In the simplest formation, the transmission gate 131 comprises a single transistor. The transmission gate 131 can be any state-of-the-art transmission gate such as a parallel configuration of p- and n- channel transistors.

The comparator circuit 132 is preferably a differential amplifier. The differential amplifier shown in Fig. 5 comprises an operational amplifier with the bias resistors R_F and R_i , together with the supplied voltages $+V$ and $-V$. The comparator circuit 132 can be any state-of-the-art

comparator circuit, which compares two values and outputs a signal depending on the difference of those values.

The delay circuit 133 shown in Fig. 5 comprises two inverters between the output of the comparator 132 and the input of the feedback circuit 134. The delay circuit 133 is inserted to stabilize the operational amplifier output waveform. The delay electronics may be omitted without causing serious effect on the operation of the resistor trimmer circuit.

The feedback circuit 134 is preferably a second transmission gate. Similar to the first transmission gate 131, the second transmission gate can be a single transistor.

The operation of the above resistor trimmer circuit preferably requires the timing of the gate functions. Fig. 6 shows the timing of the transmission gates. G1 is the waveform of the gate control 141 of the first transmission gate. G2 is the waveform of the gate control 144 of the second transmission gate. O1 and O2 are the waveforms of the output 143 of the delay circuit 133 for different values of the matching resistor R_2 , when the resistance of the matching resistor R_2 is higher than that of the reference resistor R_1 (signal O1), and when it is lower than the reference resistor (signal O2), respectively.

The first transmission gate 131 opens for a time T1 for the operational amplifier 132 to sense the bridge valence voltage. The time T1 for the

first transmission gate open is preferably between 5 ns to 100 ns. The second transmission gate 134 opens after the first transmission gate 131 closes ($T_4 > 0$, i.e. there is a delay time between the close of gate 131 and the opening of gate 134), and the second transmission gate 134 closes before the next opening of the first transmission gate 131 ($T_5 > 0$, i.e. there is a delay time between the close of gate 134 and the next opening of gate 131). During the transmission gate 134 opening time, the signal propagates through the delay circuit 133 and feeds to the resistance bridge 130. The opening time of the second transmission gate 134 is preferably long enough so that the pulse duration feeding to the matching resistor R_2 is determined by T_1 , the pulse width of the first transmission gate 131 pulse. If the opening time of the second transmission gate 134 is not long enough, the pulse duration feeding to the matching resistor R_2 may be determined by the pulse width of the second transmission gate 134 pulse minus any other timing delays. T_2 is the delay time of the delay circuit 133, preferably larger than the combination of T_1 and T_4 ($T_2 > T_1 + T_4$) to ensure that the generated pulse can propagate through the second transmission gate opening and not traveling back to the first transmission gate.

When the resistance of the matching resistor R_2 is larger than the resistance of the reference resistor R_1 , the voltage at point A is smaller than the voltage at point B ($V_B > V_A$). Therefore the output voltage pulse

at point 143 is positive (shown as O1 in the timing of Fig. 6), and a narrow positive voltage pulse is applied to the matching resistor R_2 during the opening of the second transmission gate 134. The matching resistor R_2 is configured so that a positive voltage pulse will reduce the resistance of the matching resistor R_2 . The position of the resistors in the resistance bridge, the polarities of the operational amplifier and the delay circuit, together with the configuration of the matching resistor R_2 are designed so that the feedback circuit is a negative feedback, meaning a higher resistance value of the matching resistor R_2 will receive a signal pulse to reduce the resistance, and vice versa.

If after the reduced pulse, the resistance of the matching resistor R_2 is still larger than the reference resistor R_1 , the voltage V_B is still higher than the voltage V_A , and the next pulse is still positive to further reduce the resistance of the matching resistor R_2 .

When the resistance of the matching resistor R_2 is smaller than the reference resistor R_1 , the voltage V_A will be higher than the voltage V_B ($V_A > V_B$), and the output voltage pulse at point 143 (shown as O2 in the timing of Fig. 6) is negative and the pulse applied to the matching resistor R_2 will act to increase the resistance of the matching resistor R_2 .

The rate of increase or decrease of the matching resistor R_2 depends on the width and the amplitude of the trimming pulses. The width of the trimming pulses is controlled either by the pulse width T_1 of the opening time of the first transmission gate 131, or by the pulse width of opening

time of the second transmission gate 134, whichever is smaller. The amplitude of the trimming pulses is controlled by the power supply voltage of the delay circuit.

The precision of the resistance trimming is controlled by these two parameters, the pulse width and the pulse amplitude, together with the sensitivity of the amplifier. Higher precision trimming is obtained by narrower pulse width and lower pulse amplitude, but it will require longer trimming time, or larger number of trimming pulses. The initial resistance of the matching resistor R_2 is not critical. It can be either larger or smaller than the resistance of the reference resistor R_1 .

While this invention has been described fully and completely, it should be understood that within the scope of the appended claims, the invention may be practiced otherwise than as specifically described. Although the invention has been disclosed with reference to its preferred embodiments, from reading this description those skilled in the art may appreciate changes and modifications that may be made which do not depart from the scope and spirit of the invention as described above and claimed hereafter.

**This Page is Inserted by IFW Indexing and Scanning
Operations and is not part of the Official Record**

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

- ☐ BLACK BORDERS
- ☐ IMAGE CUT OFF AT TOP, BOTTOM OR SIDES
- ☒ FADED TEXT OR DRAWING
- ☐ BLURRED OR ILLEGIBLE TEXT OR DRAWING
- ☐ SKEWED/SLANTED IMAGES
- ☐ COLOR OR BLACK AND WHITE PHOTOGRAPHS
- ☐ GRAY SCALE DOCUMENTS
- ☐ LINES OR MARKS ON ORIGINAL DOCUMENT
- ☐ REFERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY
- ☒ OTHER: FAXED DOC

IMAGES ARE BEST AVAILABLE COPY.

As rescanning these documents will not correct the image problems checked, please do not report these problems to the IFW Image Problem Mailbox.